IN THE UNITED STATES PATENT AND TRADEMARK OFFICE ı 2 Priority Filing Date March 30, 1999 Inventor Eugene P. Marsh 3 Assignee Micron Technology, Inc. Attorney's Docket No. MI22-1284 5 Circuitry Comprising Roughened Platinum Layers. Platinum-Title: Containing Materials, Capacitors Comprising Roughened 6 Platinum Layers, Methods of Forming Roughened Layers of Platinum, and Methods of Forming Capacitors 7 8 PRELIMINARY AMENDMENT 9 To: Assistant Commissioner for Patents 10 Washington, D.C. 20231 11 David G. Latwesen (Tel. 509-624-4276; Fax 509-838-3424) From: 12 Wells, St. John, Roberts, Gregory & Matkin P.S. 601 W. First Avenue, Suite 1300 13 Spokane, WA 99201-3828 14 15 <u>AMENDMENTS</u> 16 In the Specification 17 At p. 1, before the "Technical Field" section, insert 18 -RELATED PATENT DATA 19 This patent resulted from a continuation application of U.S. Patent PATS, 990,559 20 Application Serial No. 09/281,735, which was filed on March 30, 1999, 21 which is a divisional application of U.S. Patent Application Serial PAT 0,583,022 22 No. 09/141,840, which was filed on August 27, 1998,

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